

NOTES:

MATERIAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE $t=0.30\text{mm}$.
3. PLATING : SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATING OVER NICKEL IN SOLDER AREA

4. SHIELD: : 0.20mm THICKNESS COPPER ALLY WITH NICKEL PLATE
ELECTRICAL:

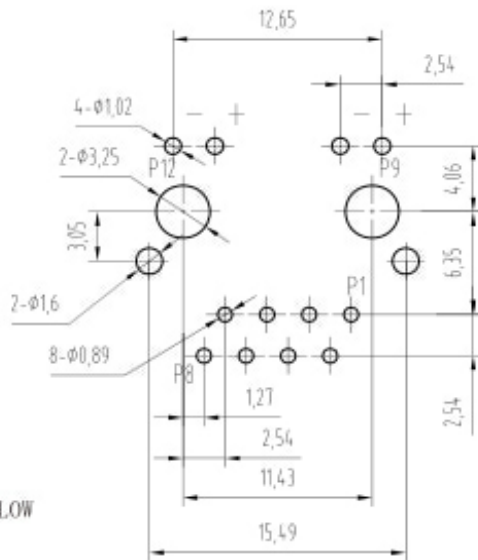
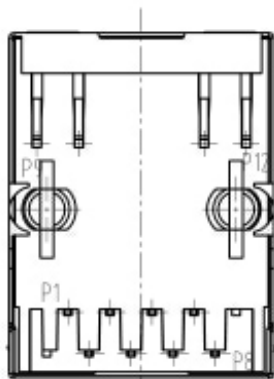
1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE : 1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

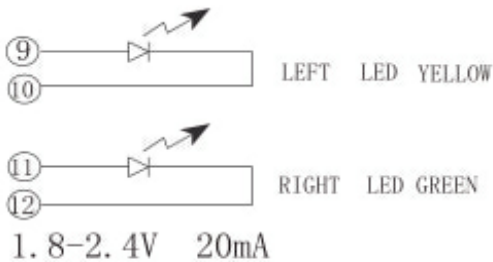
1. DURRABILITY : 750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO 85°C .
2. OPERATION : 0°C TO 70°C .



PC Board Layout
Component Side Shown



深圳市金航标电子有限公司					WWW.BDS666.COM		
KH-5922S-8P8C-D					0755-83044319		
单位(units)	MM	设计(draw)	邓辉剑	材料(mat 1)	图名(name)	RJ45 JACK 90° 屏蔽带灯	
比例(scale)	1 : 1	审核(ch'k)	朱建华	UNIT:mm xx +/0.25, xxx +/-0.13			
版次(rev.)	A / 1	核准(app'd)	朱建华	HOUSING	料号(Part number)	5922S- 8P8C-1X1	
视图(view)		日期(date)	2008.08.12	PIN	档号(File Name)	E:\工程图	

单击下面可查看定价，库存，交付和生命周期等信息

[>>kinghelm\(金航标\)](#)